

$V_{RSM} = 40\text{ V}$, $I_{F(AV)} = 5.0\text{ A}$
Schottky Diode
SJPW-T4

Description

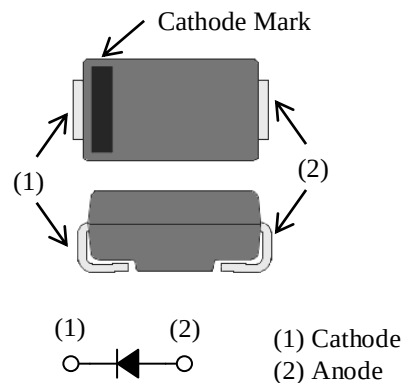
The SJPW-T4 is a 40 V, 5.0 A Schottky diode that has the improved characteristics of V_F and I_R . These characteristics realize the improvement of power supply efficiency and the high frequency system.

Features

- V_{RSM} ----- 40 V
- $I_{F(AV)}$ ----- 5.0 A
- V_F ($I_F = 5.0\text{ A}$) ----- 0.49 V typ.
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Suitable for High Reliability and Automotive Requirement

Package

SJP



Not to scale

Applications

High speed switching applications as follows:

- DC-DC Converter
- Adapter

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		40	V
Repetitive Peak Reverse Voltage	V_{RM}		40	V
Average Forward Current	$I_{F(AV)}$	See Figure 2 and Figure 3	5.0	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	80	A
I^2t Limiting Value	I^2t	$1\text{ ms} \leq t \leq 10\text{ ms}$	32	A^2s
Junction Temperature	T_J		-40 to 150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}		-40 to 150	$^{\circ}\text{C}$

Electrical Characteristics

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop	V_F	$I_F = 5.0\text{ A}$	—	0.49	0.55	V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	—	—	500	μA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150\text{ }^{\circ}\text{C}$	—	—	150	mA
Thermal Resistance ⁽¹⁾	$R_{th(J-L)}$		—	—	20	$^{\circ}\text{C/W}$

Mechanical Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Package Weight		—	0.072	—	g

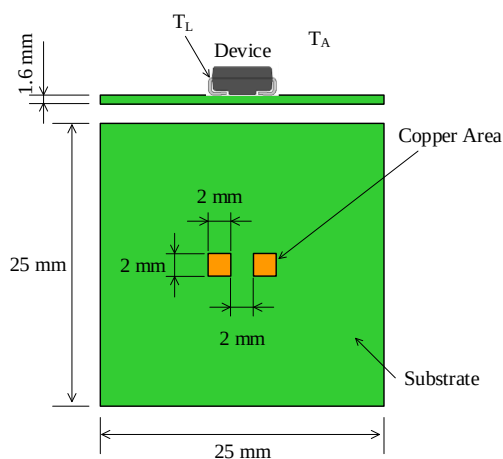


Figure 1. Lead Temperature Measurement Conditions

⁽¹⁾ $R_{th(J-L)}$ is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1).

Derating Curves

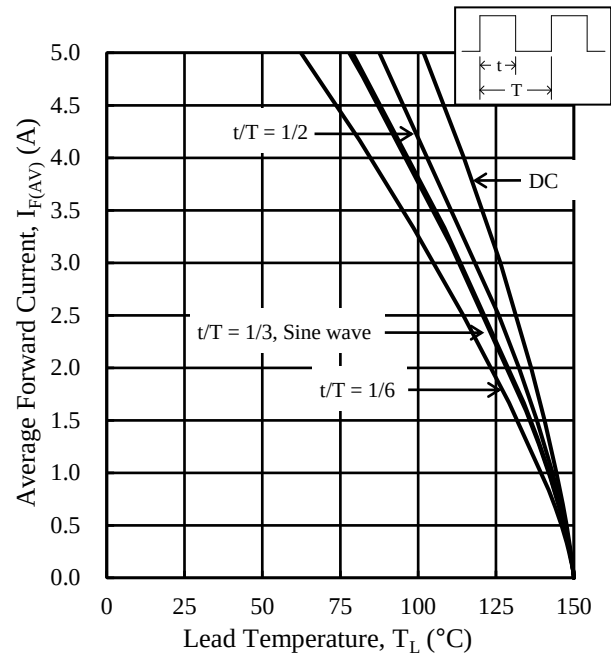


Figure 2. $I_{F(AV)}$ vs. T_L ($T_J = 150$ °C, $V_R = 0$ V)

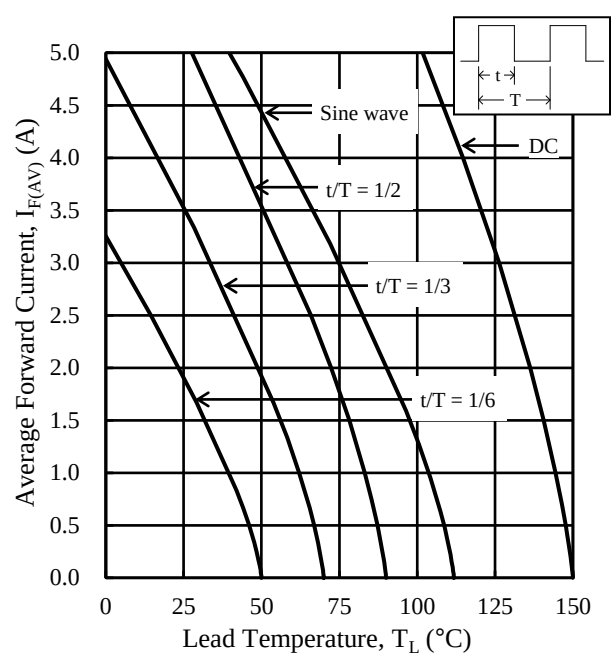


Figure 3. $I_{F(AV)}$ vs. T_L ($T_J = 150$ °C, $V_R = 40$ V)

Characteristic Curves

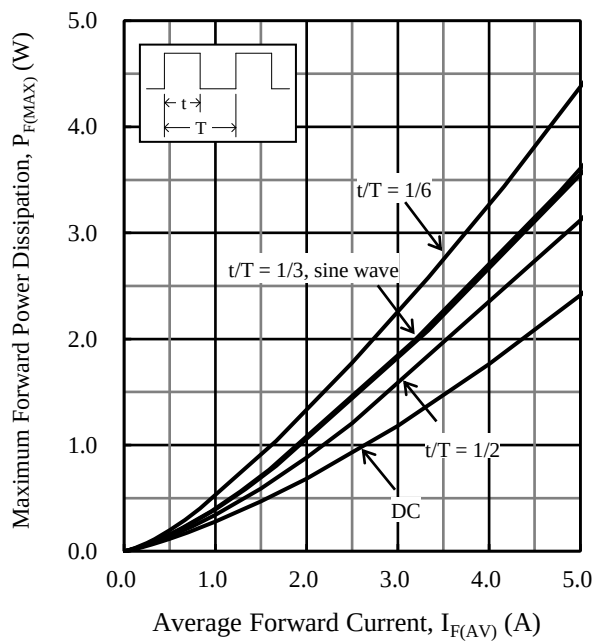


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150\text{ }^{\circ}\text{C}$)

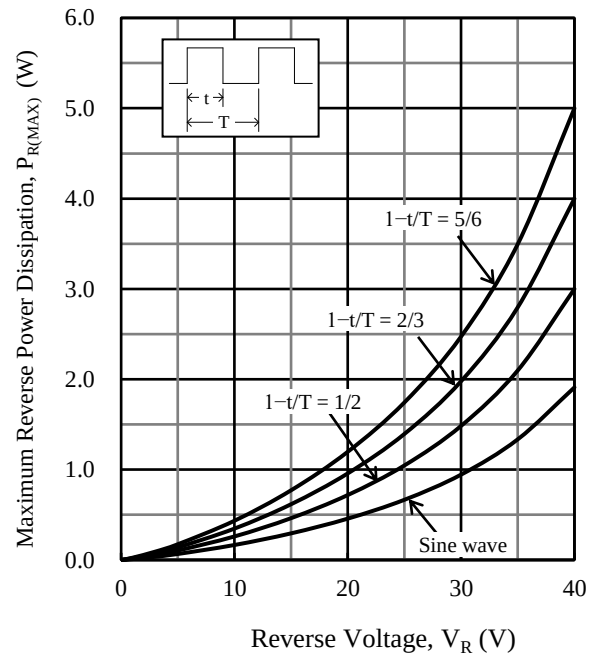


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150\text{ }^{\circ}\text{C}$)

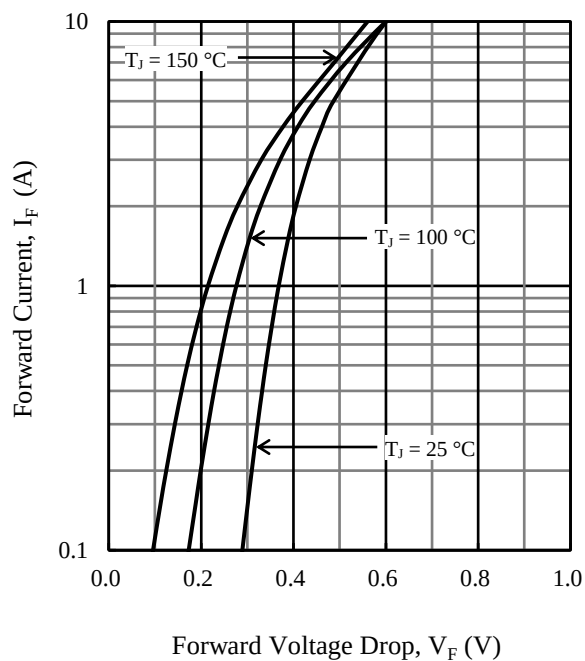


Figure 6. Typical Characteristics: I_F vs. V_F

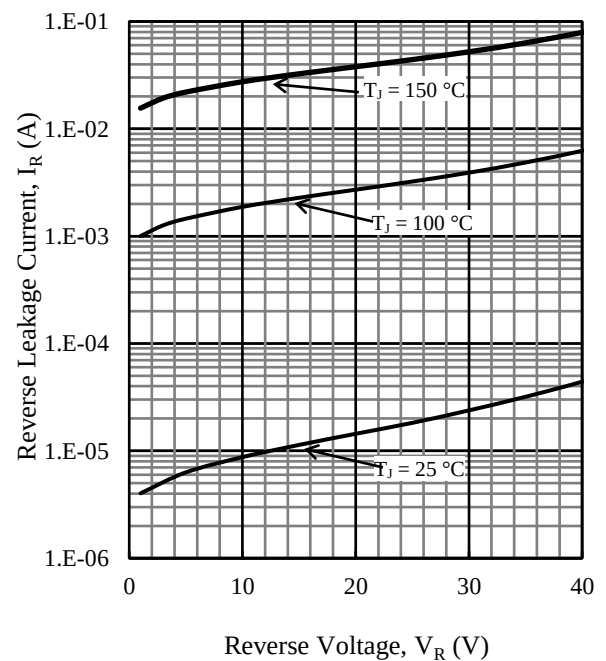


Figure 7. Typical Characteristics: I_R vs. V_R

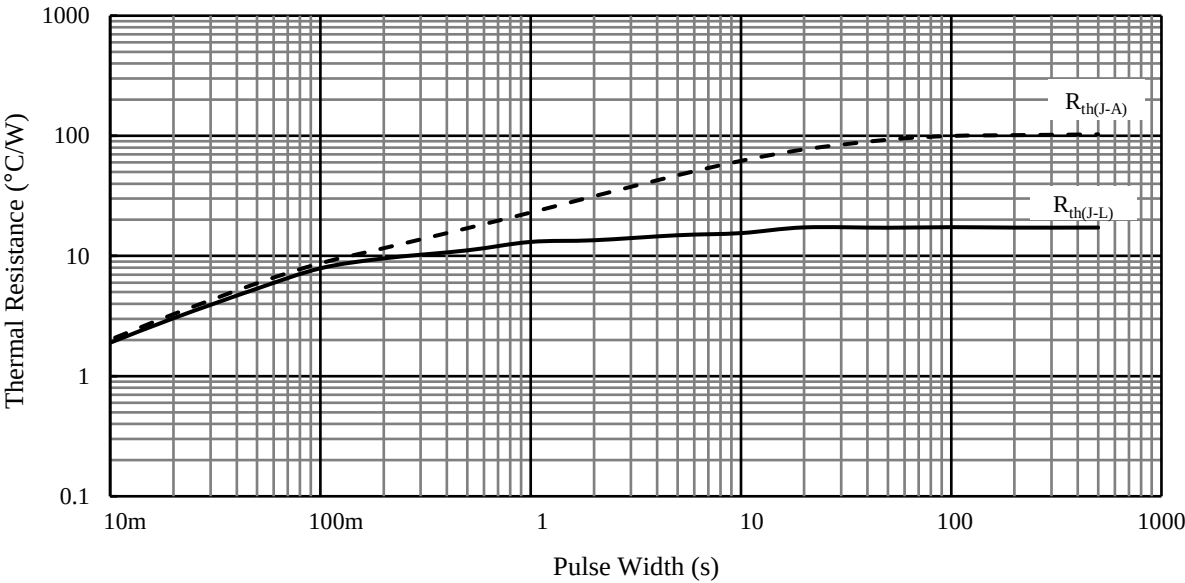
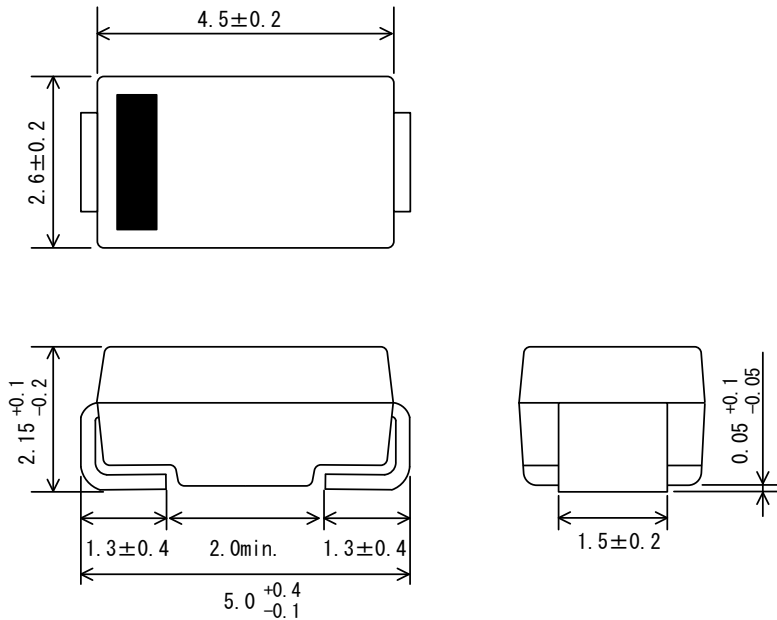


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• SJP Package



NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- Moisture Sensitivity Level 1 (MSL 1)

When soldering the products, it is required to minimize the working time within the following limits:

Flow: 260 °C / 10 s, 1 time

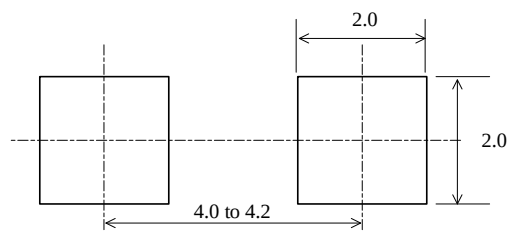
Reflow:

Preheat: 150 °C to 200 °C / 60 s to 120 s

Solder heating: 255 °C / 30s, 3 times (260 °C peak)

Soldering Iron: 350 °C / 3.5 s, 1 time

• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram

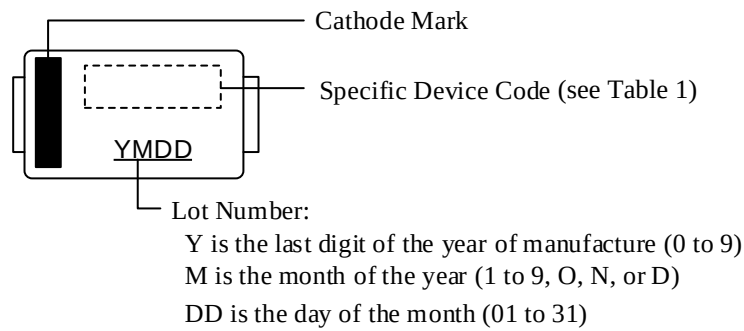


Table 1. Specific Device Code

Specific Device Code	Part Number
WT4	SJPW-T4

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